



| Parameter | Rating | Units |
|--|--------|-------|
| Breakdown Voltage - BV_{CEO} | 30 | V_P |
| Current Transfer Ratio - CTR (typical) | 8500 | % |
| Saturation Voltage - $V_{CE(sat)}$ | 1 | V |
| Input Control Current - I_F | 1 | mA |

Features

- 100mA Continuous Load Rating
- 3750V_{rms} Input/Output Isolation
- Unidirectional Input
- Small 6-Pin Package, Thru-Hole or Surface Mount
- Machine Insertable, Wave Solderable
- Surface Mount Tape & Reel Packaging Available

Applications

- Telecom Switching
- Tip/Ring Circuits
- Modem Switching (Laptop, Notebook, Pocket Size)
- Loop Detect
- Ringing Detect
- Current Sensing

Description

LDA111 is a unidirectional-input optocoupler with a Darlington-transistor output. The LDA111 has a minimum current transfer ratio (CTR) of 300% with a maximum value of 30,000%.

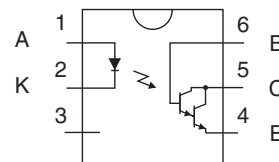
Approvals

- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1175739
- EN/IEC 60950-1 Certified Component:
TUV Certificate B 09 07 49410 006

Ordering Information

| Part Number | Description |
|-------------|---------------------------------|
| LDA111 | 6-Pin DIP (50/tube) |
| LDA111S | 6-Pin Surface Mount (50/tube) |
| LDA111STR | 6-Pin Surface Mount (1000/Reel) |

Pin Configuration



Absolute Maximum Ratings @ 25°C

| Parameter | Ratings | Units |
|--------------------------------------|-------------|------------------|
| Breakdown Voltage | 30 | V _P |
| Reverse Input Voltage | 5 | V |
| Input Control Current | 100 | mA |
| Peak (10ms) | 1 | A |
| Power Dissipation | | |
| Input Power Dissipation ¹ | 150 | mW |
| Phototransistor ² | 150 | |
| Isolation Voltage, Input to Output | 3750 | V _{rms} |
| Operational Temperature | -40 to +85 | °C |
| Storage Temperature | -40 to +125 | °C |

¹ Derate linearly 1.33mW / °C

² Derate linearly 2mW / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

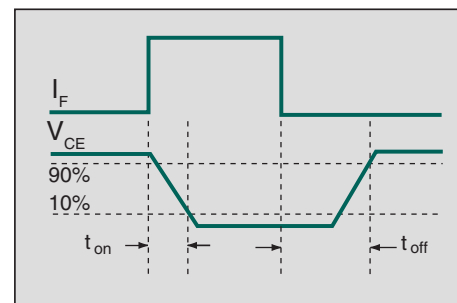
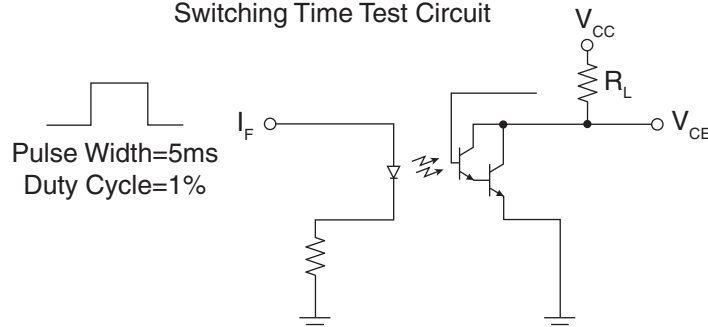
Electrical Characteristics @ 25°C

| Parameter | Conditions | Symbol | Min | Typ | Max | Units |
|-----------------------------------|---|----------------------|-----|------|-------|-------|
| Output Characteristics | | | | | | |
| Phototransistor Breakdown Voltage | I _C = 100µA | BV _{CEO} | 30 | 85 | - | V |
| Phototransistor Dark Current | V _{CEO} = 5V, I _F = 0mA | I _{CEO} | - | 50 | 500 | nA |
| Saturation Voltage | I _C = 3mA, I _F = 1mA | V _{CE(sat)} | - | - | 1 | V |
| Current Transfer Ratio | I _F = 1mA, V _{CE} = 2V | CTR | 300 | 8500 | 30000 | % |
| Output Capacitance | 25V, f = 1MHz | C _{OUT} | - | 3 | - | pF |
| Input Characteristics | | | | | | |
| Input Control Current | I _C = 3mA, V _{CE} = 2V | I _F | - | 0.07 | 1 | mA |
| Input Voltage Drop | I _F = 5mA | V _F | 0.9 | 1.2 | 1.4 | V |
| Reverse Input Current | V _R = 5V | I _R | - | - | 10 | µA |
| Common Characteristics | | | | | | |
| Capacitance, Input to Output | - | C _{I/O} | - | 3 | - | pF |

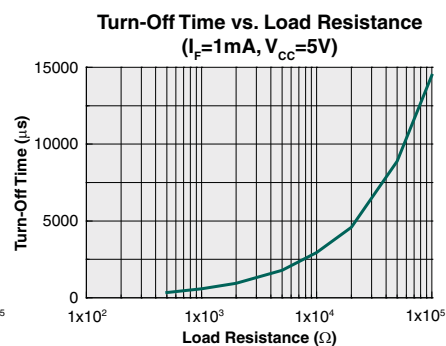
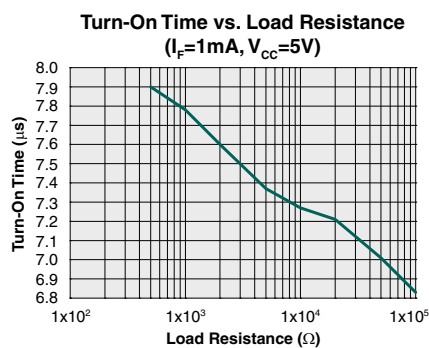
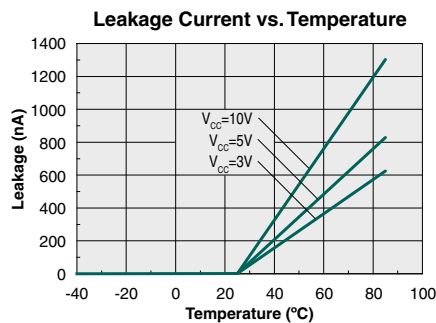
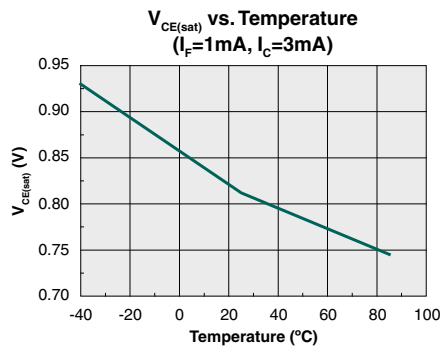
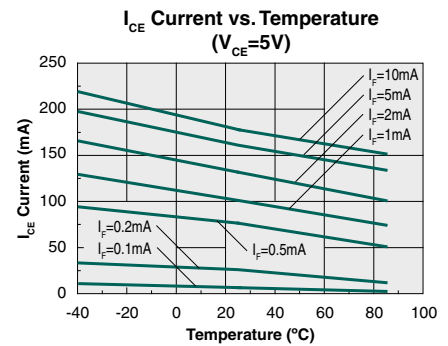
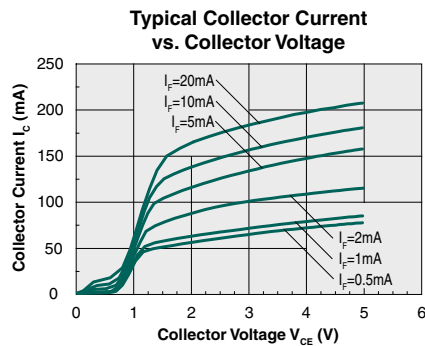
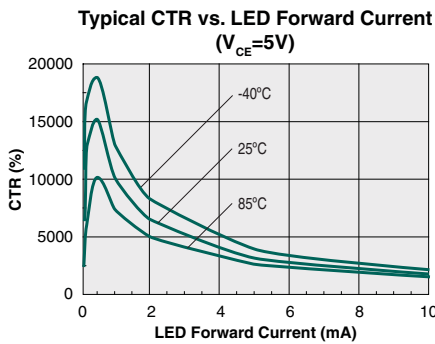
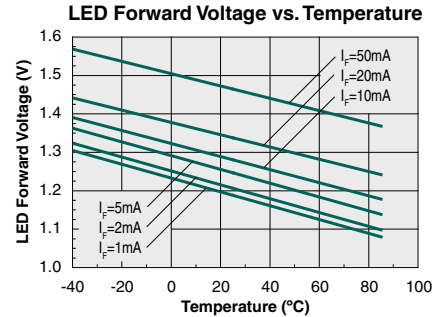
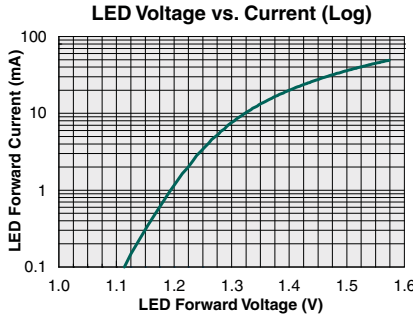
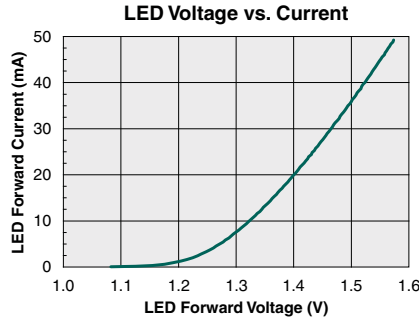
Switching Characteristics @ 25°C

| Characteristic | Symbol | Test Condition | Typ | Units |
|----------------|------------------|--|-----|-------|
| Turn-On Time | t _{on} | V _{CC} =5V, I _F =1mA, R _L =500Ω | 8 | µs |
| Turn-Off Time | t _{off} | | 345 | |

Switching Time Test Circuit



PERFORMANCE DATA @25°C (Unless Otherwise Noted)*



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

Manufacturing Information

Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

| Device | Moisture Sensitivity Level (MSL) Rating |
|------------------|---|
| LDA111 / LDA111S | MSL 1 |

ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

| Device | Maximum Temperature x Time |
|------------------|----------------------------|
| LDA111 / LDA111S | 250°C for 30 seconds |

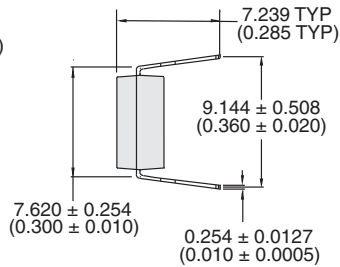
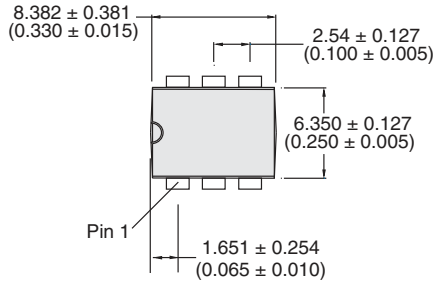
Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

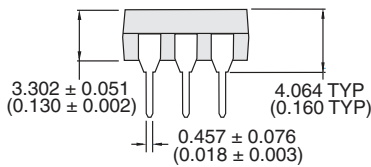
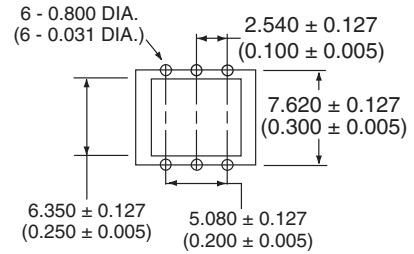


Mechanical Dimensions

LDA111

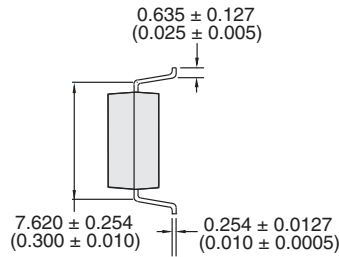
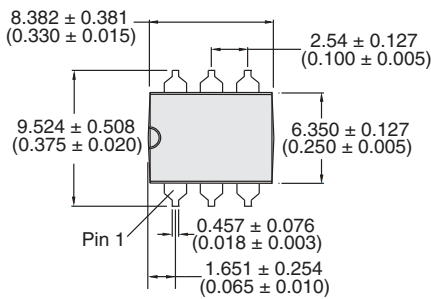


PCB Hole Pattern

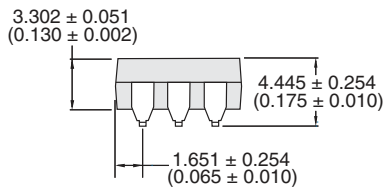
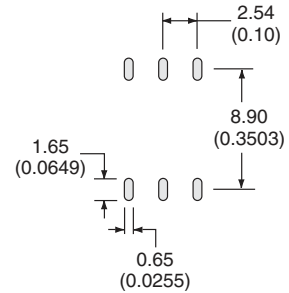


Dimensions
mm
(inches)

LDA111S

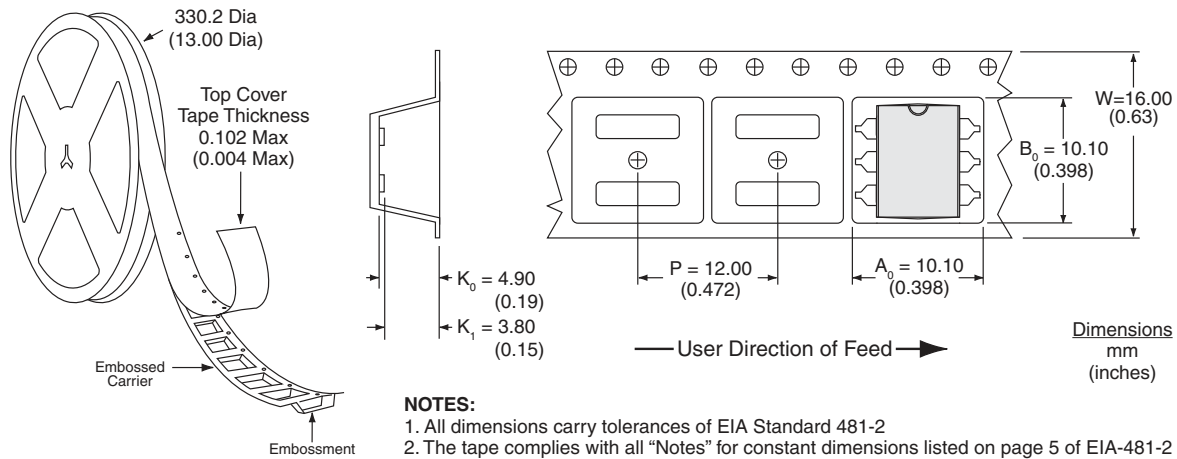


PCB Land Pattern



Dimensions
mm
(inches)

LDA111STR Tape & Reel



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